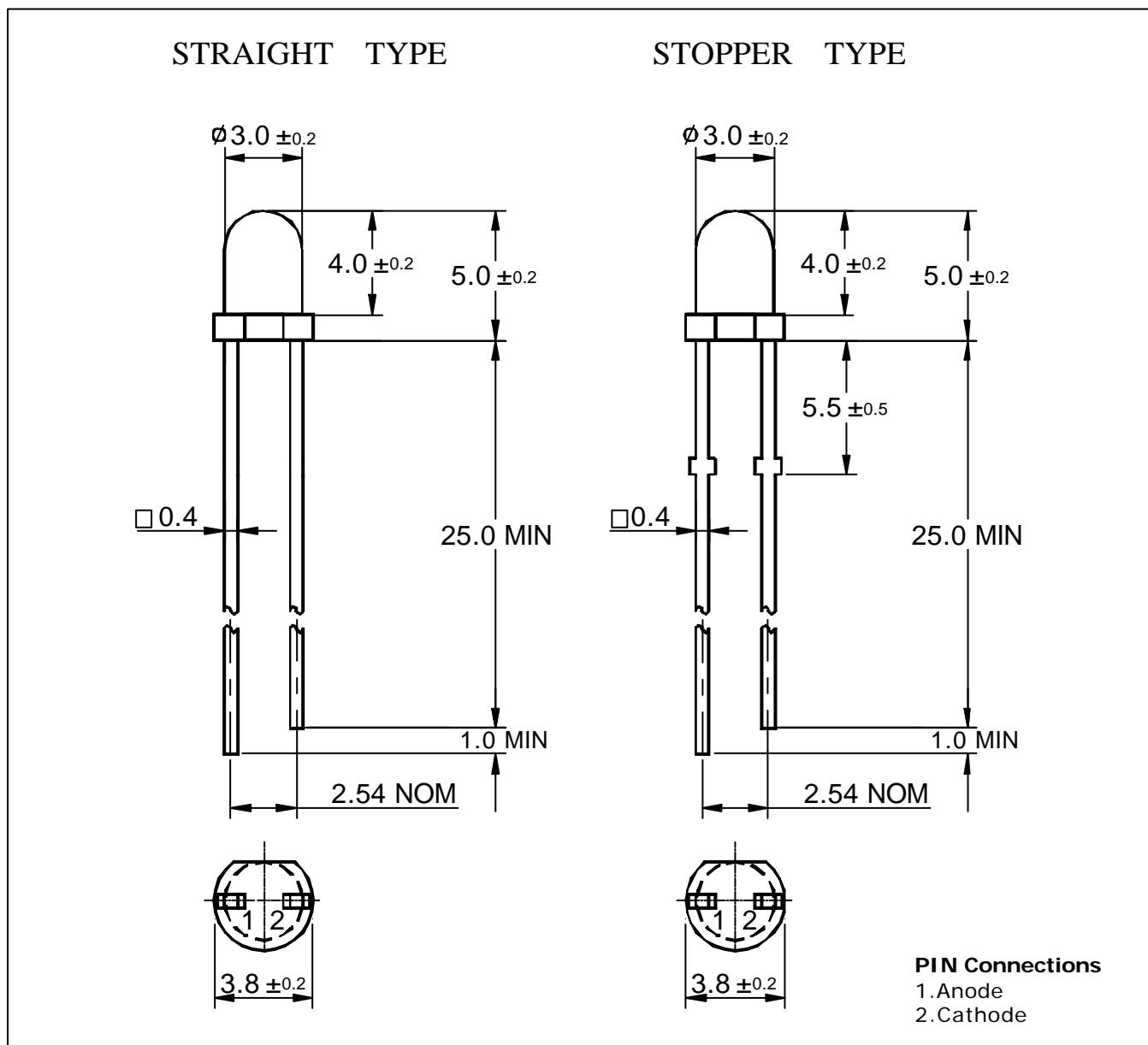


## Features

- Red Colored diffusion lens type
- $\phi 3\text{mm}$ (T-1) all plastic mold type
- Low power consumption

## Outline Dimensions

**unit : mm**



## Absolute maximum ratings

Characteristic	Symbol	Ratings	Unit
Power Dissipation	P <sub>D</sub>	85	mW
Forward Current	I <sub>F</sub>	30	mA
* <sup>1</sup> Peak Forward Current	I <sub>FP</sub>	50	mA
Reverse Voltage	V <sub>R</sub>	4	V
Operating Temperature	T <sub>opr</sub>	-25 85	
Storage Temperature	T <sub>stg</sub>	-30 100	
* <sup>2</sup> Soldering Temperature	T <sub>sol</sub>	260 for 5 seconds	

\*1.Duty ratio = 1/16, Pulse width = 0.1ms

\*2.Keep the distance more than 2.0mm from PCB to the bottom of LED package

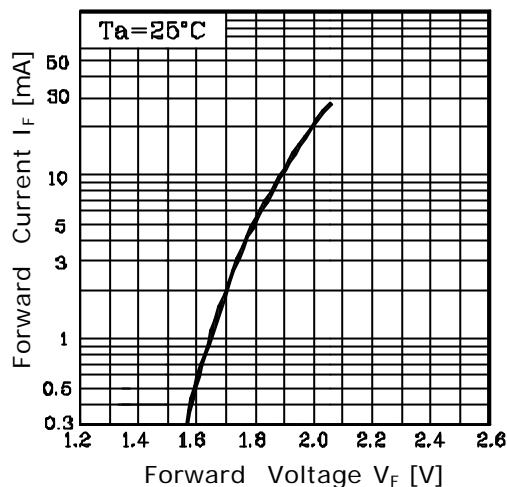
## Electrical Characteristics

Characteristic	Symbol	Test Condition	Min	Typ	Max	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 20mA	-	2.0	2.7	V
Luminous Intensity	I <sub>V</sub>	I <sub>F</sub> = 20mA	-	40	-	mcd
Peak Wavelength	λ <sub>P</sub>	I <sub>F</sub> = 20mA	-	630	-	nm
Spectrum Bandwidth		I <sub>F</sub> = 20mA	-	35	-	nm
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =4V	-	-	10	μA
* <sup>3</sup> Half Angle	θ1/2	I <sub>F</sub> = 20mA	-	±20	-	deg

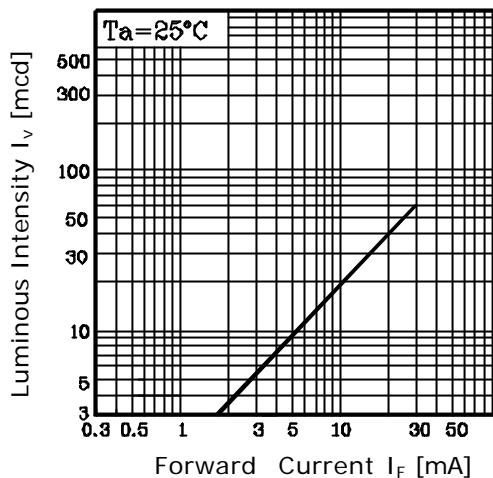
\*3. θ1/2 is the off-axis angle where the luminous intensity is 1/2 the peak intensity

## Characteristic Diagrams

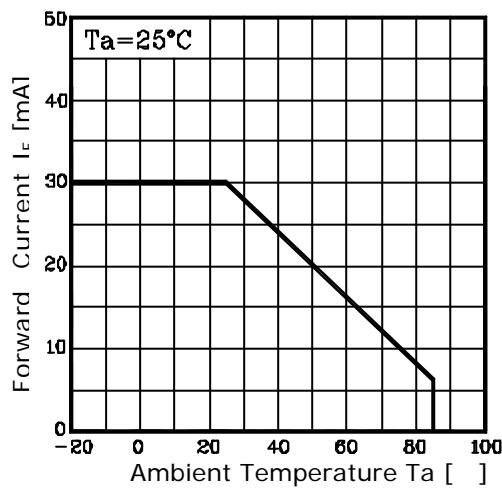
**Fig. 1**  $I_F$  -  $V_F$



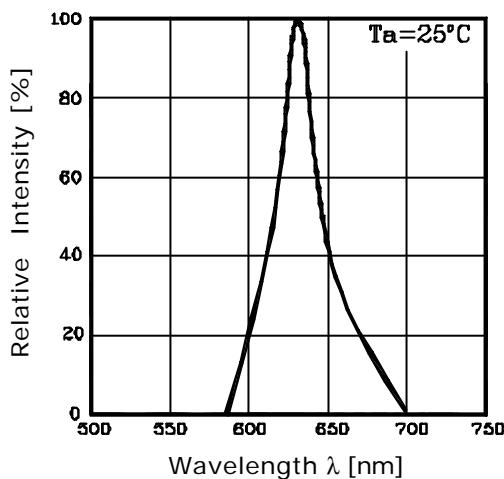
**Fig. 2**  $I_V$  -  $I_F$



**Fig. 3**  $I_F$  -  $T_a$



**Fig.4** Spectrum Distribution



**Fig. 5** Radiation Diagram

